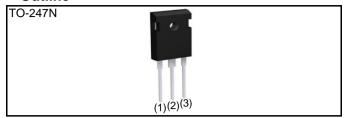


# SCT3105KL

## **N-channel SiC power MOSFET**

$V_{\mathrm{DSS}}$	1200V
R <sub>DS(on)</sub> (Typ.)	105mΩ
I <sub>D</sub> <sup>*1</sup>	24A
$P_{D}$	134W

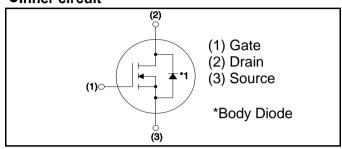
#### Outline



#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant

#### ●Inner circuit



## Application

- · Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

### Packaging specifications

	Packing	Tube
	Reel size (mm)	-
Typo	Tape width (mm)	-
Type	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT3105KL

### ● **Absolute maximum ratings** (T<sub>vi</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		$V_{DSS}$	1200	V
Continuous Drain current	T <sub>c</sub> = 25°C	I <sub>D</sub> *1	24	А
Continuous Diam current	T <sub>c</sub> = 100°C	I <sub>D</sub> *1	17	Α
Pulsed Drain current(T <sub>c</sub> = 25°C)		I <sub>D,pulse</sub> *2 60		А
Gate - Source voltage (DC)		$V_{GSS}$	-4 to +22	V
Gate - Source surge voltage (t <sub>surge</sub> < 300nsec)		V <sub>GSS_surge</sub> *3	-4 to +26	V
Recommended drive voltage		$V_{GS\_op}^{^{*4}}$	0 / +18	V
Virtual Junction temperature		T <sub>vj</sub>	175	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +175	°C

## ●Electrical characteristics (T<sub>vj</sub> = 25°C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
		$V_{GS} = 0V$ , $I_D = 1mA$				
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$T_{vj} = 25^{\circ}C$	1200	-	-	V
renage		T <sub>vj</sub> = -55°C	1200	-	-	
		$V_{GS} = 0V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	I <sub>DSS</sub>	$T_{vj} = 25^{\circ}C$	-	1	10	μΑ
Diam ourient		T <sub>vj</sub> = 150°C	-	2	-	
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +22V$ , $V_{DS} = 0V$	-		100	nA
Gate - Source leakage current	I <sub>GSS-</sub>	$V_{GS} = -4V$ , $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	V <sub>GS (th)</sub>	$V_{DS} = 10V, I_{D} = 3.81 \text{mA}$	2.7		5.6	V
		$V_{GS} = 18V, I_D = 7.6A$				
Static Drain - Source on - state resistance	R <sub>DS(on)</sub> *5	T <sub>vj</sub> = 25°C	-	105	137	mΩ
on state registance		T <sub>vj</sub> = 150°C	-	179	-	
Gate input resistance	$R_{G}$	f = 1MHz, open drain	-	13	-	Ω

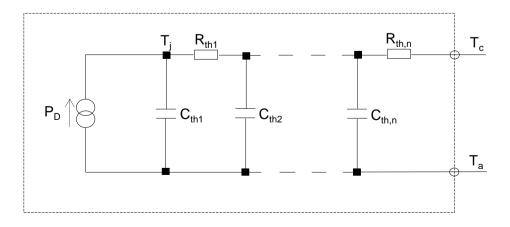
### Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	$R_{thJC}$	-	0.86	1.12	K/W

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R <sub>th1</sub>	1.08E-01	
R <sub>th2</sub>	3.73E-01	K/W
R <sub>th3</sub>	3.41E-01	

Symbol	Value	Unit
C <sub>th1</sub>	4.72E-04	
$C_{th2}$	3.97E-03	Ws/K
$C_{th3}$	1.31E-02	



## •Electrical characteristics ( $T_{vj} = 25$ °C unless otherwise specified)

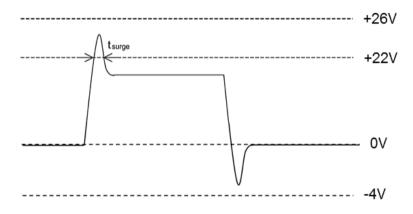
Doromotor	Cymbal	Conditions		Values		Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	<b>g</b> fs *5	$V_{DS} = 10V, I_{D} = 7.6A$	-	3.4	-	S
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	574	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 800V	-	59	-	pF
Reverse transfer capacitance	$C_{rss}$	f = 1MHz	-	28	-	
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 600V$	-	159	-	pF
Total Gate charge	Qg *5	$V_{DS} = 600V$ $I_{D} = 7.6A$	1	51	-	
Gate - Source charge	Q <sub>gs</sub> *5	$V_{GS} = 18V$	-	10	-	nC
Gate - Drain charge	Q <sub>gd</sub> *5	See Fig. 1-1.	1	25	-	
Turn - on delay time	t <sub>d(on)</sub> *5	$V_{DS} = 400V$ $I_{D} = 7.6A$	ı	17	-	
Rise time	t <sub>r</sub> *5	$V_{GS} = 0V/+18V$	-	27	-	ns
Turn - off delay time	t <sub>d(off)</sub> *5	$R_G = 0\Omega$ $R_L = 53\Omega$	ı	31	-	113
Fall time	t <sub>f</sub> *5	See Fig. 1-1, 1-2.	ı	17	-	
Turn - on switching loss	E <sub>on</sub> *5	$V_{DS} = 600V$ $V_{GS} = 0V/18V$ , $I_{D} = 7.6A$ $R_{G} = 0\Omega$ , $L = 750\mu H$	-	159	-	., 1
Turn - off switching loss	E <sub>off</sub> *5	$E_{on}$ includes diode reverse recovery $L_{\sigma}$ = 50nH, $C_{\sigma}$ = 200pF See Fig. 2-1, 2-2.	-	2	-	μJ

## ●Body diode electrical characteristics (Source-Drain) (T<sub>vj</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Body diode continuous, forward current	I <sub>S</sub> *1	T <sub>c</sub> = 25°C	ı	ı	24	А
Body diode direct current, pulsed	I <sub>SM</sub> *2	11 <sub>c</sub> = 23 0	ı	ı	60	Α
Forward voltage	V <sub>SD</sub> *5	$V_{GS} = 0V, I_{S} = 7.6A$	•	3.2	•	V
Reverse recovery time	t <sub>rr</sub> *5	$I_F = 7.6A$ $V_R = 600V$	ı	15	ı	ns
Reverse recovery charge	Q <sub>rr</sub> *5	di/dt = 1100A/µs	-	53	-	nC
Peak reverse recovery current	l <sub>rrm</sub> *5	$L_{\sigma} = 50$ nH, $C_{\sigma} = 200$ pF See Fig. 3-1, 3-2.	-	6.5		Α

<sup>\*1</sup> Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

\*3 Example of acceptable  $V_{\text{GS}}$  waveform



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\*5 Pulsed

TSQ50211-SCT3105KL

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<sup>\*2</sup> PW  $\leq$  10 $\mu$ s, Duty cycle  $\leq$  1%

<sup>\*4</sup> Please be advised not to use SiC-MOSFETs with V<sub>GS</sub> below 13V as doing so may cause thermal runaway.

0

25

#### •Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

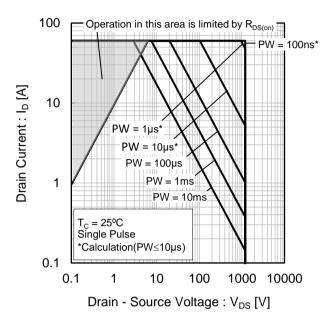


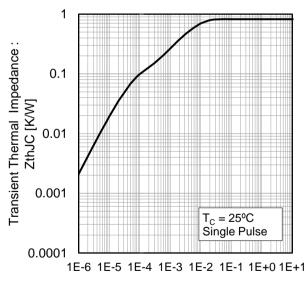
Fig.3 Typical Transient Thermal Resistance vs. Pulse Width

75

125

Case Temperature : T<sub>C</sub> [°C]

175



Pulse Width: PW [s]

Fig.4 Typical Output Characteristics(I)

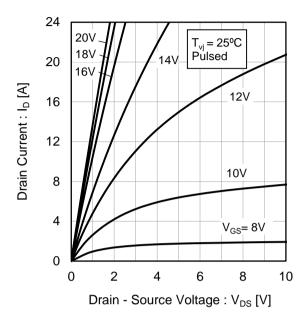


Fig.5 Typical Output Characteristics(II)

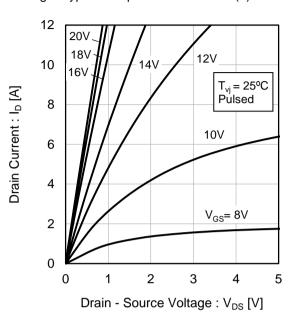
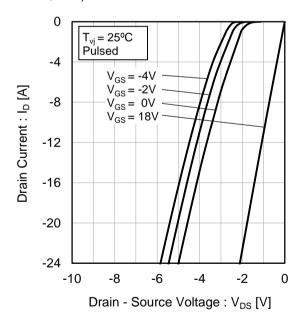
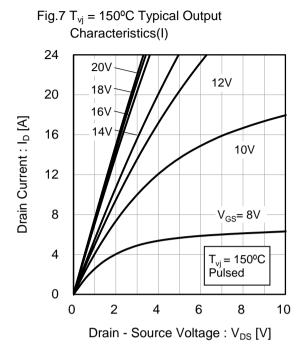
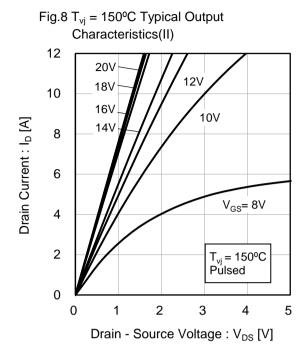


Fig.6  $T_{v_i}$  = 25°C 3rd Quadrant Characteristics

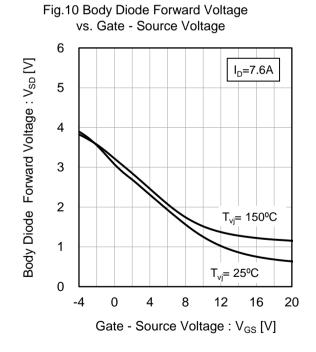






Characteristics  $T_{vi} = 150^{\circ}C$ Pulsed -4  $V_{GS} = -4V$ Drain Current: I<sub>D</sub> [A]  $V_{GS} = -2V$ -8  $V_{GS} = 0V$   $V_{GS} = 18V$ -12 -16 -20 -24 -8 -6 -10 Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.9 T<sub>vj</sub> = 150°C 3rd Quadrant



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Fig.11 Typical Transfer Characteristics (I)

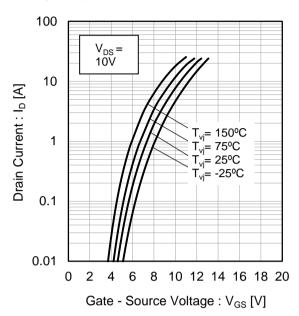


Fig.12 Typical Transfer Characteristics (II)

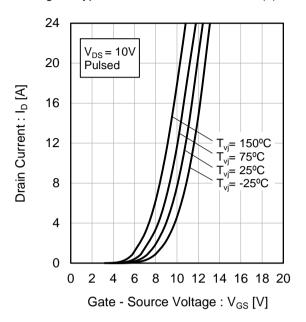


Fig.13 Gate Threshold Voltage vs. Junction Temperature

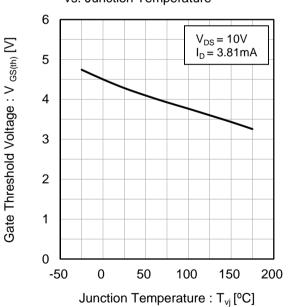
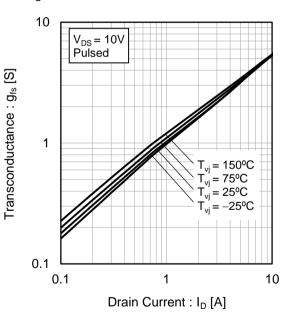


Fig.14 Transconductance vs. Drain Current



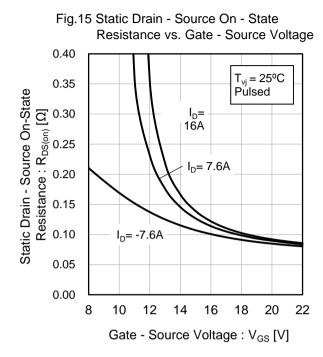


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature 0.30  $V_{GS} = 18V$ Pulsed Static Drain - Source On-State Resistance :  $R_{DS(on)}[\Omega]$ 0.24  $I_D = 16A$ 0.18 I<sub>D</sub>= 7.6A 0.12 I<sub>D</sub>= -7.6A 0.06 0.00 0 100 200 -50 50 150 Junction Temperature : T<sub>vi</sub> [°C]

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current 1 Static Drain - Source On-State Resistance:  $R_{DS(on)}[\Omega]$ 0.1 T<sub>vj</sub> = 150°C T<sub>vj</sub> = 125°C  $T_{vj} = 75^{\circ}C$  $T_{vj}^{vj} = 25^{\circ}C$  $V_{GS} = 18V$  $T_{vi} = -25^{\circ}C$ Pulsed 0.01 10 100 Drain Current: I<sub>D</sub> [A]

Voltage vs. Junction Temperature

1.04

1.03

1.00

1.00

1.01

1.00

1.00

1.00

0.99

0.98

-50

0

50

1.00

1.00

1.00

0.99

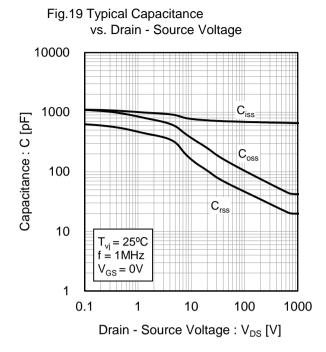
0.98

-50

Junction Temperature : T<sub>vj</sub> [°C]

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Fig.18 Normalized Drain - Source Breakdown



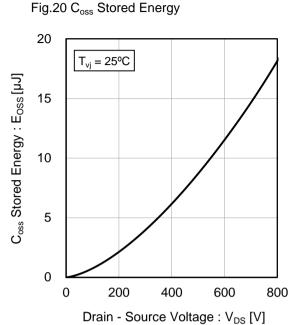
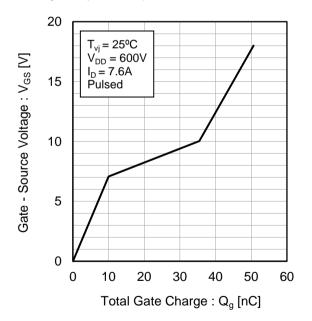


Fig.21 Dynamic Input Characteristics



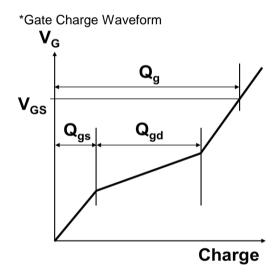


Fig.19 Typical Switching Time
vs. Drain Current

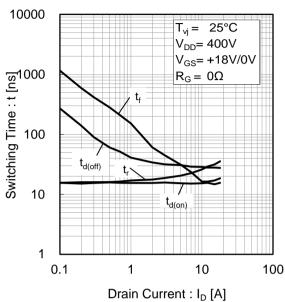


Fig.20 Typical Switching Loss vs. Drain - Source Voltage

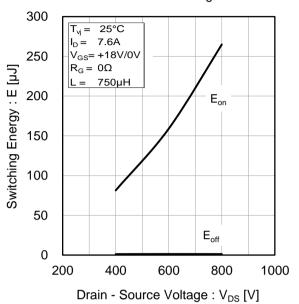


Fig.21 Typical Switching Loss vs. Drain Current

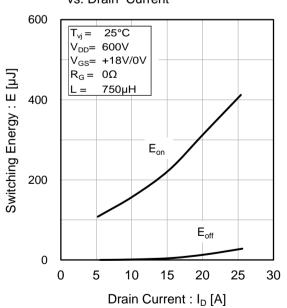
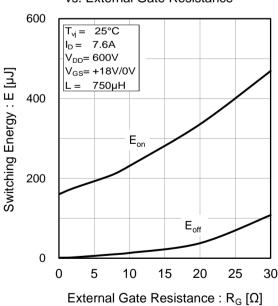


Fig.22 Typical Switching Loss vs. External Gate Resistance



#### Measurement circuits and waveforms

Fig.1-1 Gate Charge and Switching Time Measurement Circuit

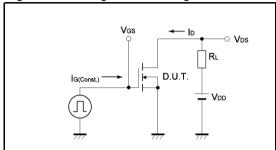


Fig.2-1 Switching Energy Measurement Circuit

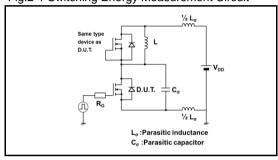


Fig.3-1 Reverse Recovery Time Measurement Circuit

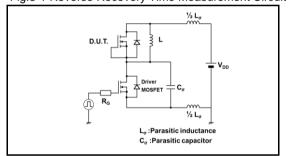


Fig.1-2 Waveforms for Switching Time

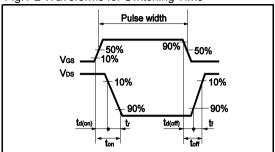


Fig.2-2 Waveforms for Switching Energy Loss

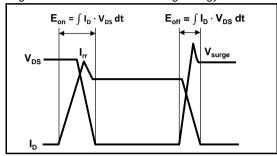
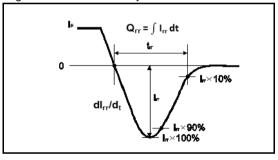
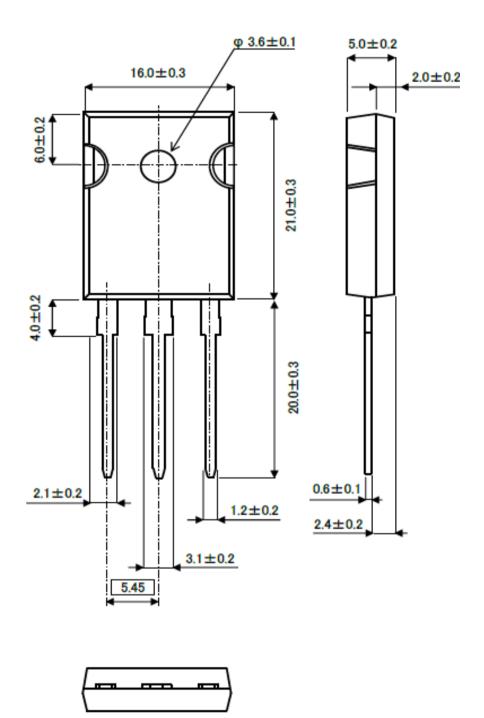


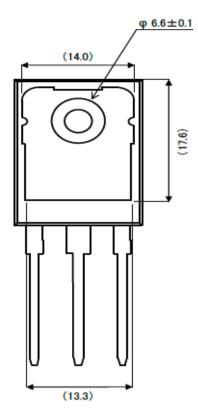
Fig.3-2 Reverse Recovery Waveform



### Package Dimensions

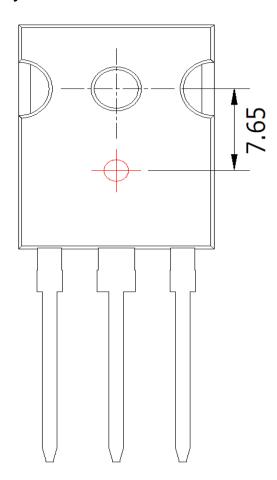


Unit: mm



Unit: mm

## **●**Die Bonding Layout





- •Front view of the packaging.
- •Dimensions are design values.
- ·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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